

20 / 20 V, 800 / 550 mA N/P-channel Trench MOSFET Rev. 1 — 6 October 2011 Product

Product data sheet

1. **Product profile**

1.1 General description

Complementary N/P-channel enhancement mode Field-Effect Transistor (FET) in an ultra small and flat lead SOT666 Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

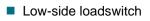
1.2 Features and benefits

- Very fast switching
- Trench MOSFET technology

1.3 Applications

- Relay driver
- High-speed line driver

- ESD protection up to 2 kV
- AEC-Q101 qualified



Switching circuits

1.4 Quick reference data

Table 1.	Quick reference data						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
TR1 (N-ch	nannel), Static characteristic	S					
R_{DSon}	drain-source on-state resistance	V_{GS} = 4.5 V; I_{D} = 500 mA; T_{j} = 25 °C		-	290	380	mΩ
TR2 (P-ch	annel), Static characteristic	S					
R _{DSon}	drain-source on-state resistance	V_{GS} = -4.5 V; I_D = -400 mA; T_j = 25 °C		-	0.67	0.85	Ω
TR1 (N-ch	nannel)						
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	20	V
V _{GS}	gate-source voltage			-8	-	8	V
I _D	drain current	V_{GS} = 4.5 V; T_{amb} = 25 °C	<u>[1]</u>	-	-	800	mA
TR2 (P-ch	nannel)						
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	-20	V
V _{GS}	gate-source voltage			-8	-	8	V
I _D	drain current	V _{GS} = -4.5 V; T _{amb} = 25 °C	<u>[1]</u>	-	-	-550	mA

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm².

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2. Pinning information

Table 2.	Pinning	g information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S1	source TR1		54 50
2	G1	gate TR1		
3	D2	drain TR2		
4	S2	source TR2	0	$G1 \left(\begin{array}{c} \\ \\ \\ \\ \\ \end{array} \right) G2$
5	G2	gate TR2		
6	D1	drain TR1	SOT666	S1 S2 017aaa262

3. Ordering information

Table 3.Ordering information			
Type number	Package		
	Name	Description	Version
PMDT290UCE	-	plastic surface-mounted package; 6 leads	SOT666

4. Marking

Table 4. M	larking codes	
Type numbe	Pr	Marking code
PMDT290UC	CE	AF

5. Limiting values

Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
TR1 (N-cha	annel)					
V _{DS}	drain-source voltage	T _j = 25 °C		-	20	V
V _{GS}	gate-source voltage			-8	8	V
I _D	drain current	V_{GS} = 4.5 V; T_{amb} = 25 °C	<u>[1]</u>	-	800	mA
		V_{GS} = 4.5 V; T_{amb} = 100 °C	<u>[1]</u>	-	500	mA
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	3.2	А
P _{tot} tot	total power dissipation	T _{amb} = 25 °C	[2]	-	330	mW
			[1]	-	390	mW
		T _{sp} = 25 °C		-	1090	mW
TR1 (N-cha	annel), Source-drain diode					
I _S	source current	T _{amb} = 25 °C	<u>[1]</u>	-	370	mA
TR1 N-char	nnel), ESD maximum rating					
V _{ESD}	electrostatic discharge voltage	HBM	[3]	-	2000	V
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Product data sheet		Rev. 1 — 6 October 2011				2 of 2

20 / 20 V, 800 / 550 mA N/P-channel Trench MOSFET

Table 5. Limiting values ...continued

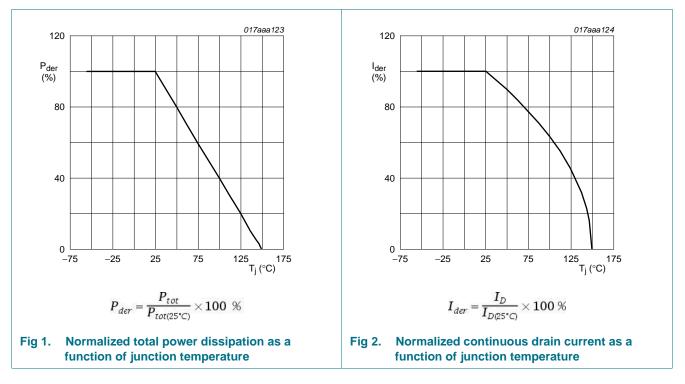
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
TR2 (P-char	nnel)					
V _{DS}	drain-source voltage	T _j = 25 °C		-	-20	V
V _{GS}	gate-source voltage			-8	8	V
I _D	drain current	V_{GS} = -4.5 V; T_{amb} = 25 °C	<u>[1]</u>	-	-550	mA
		V_{GS} = -4.5 V; T_{amb} = 100 °C	<u>[1]</u>	-	-350	mA
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-2.2	А
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	330	mW
			[1]	-	390	mW
		T _{sp} = 25 °C		-	1090	mW
TR2 (P-char	nnel), Source-drain diode					
I _S	source current	T _{amb} = 25 °C	<u>[1]</u>	-	-370	mA
TR2 (P-char	nnel), ESD maximum rating					
V _{ESD}	electrostatic discharge voltage	НВМ	[3]	-	2000	V
Per device						
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	500	mW
Tj	junction temperature			-55	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm².

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper; tin-plated and standard footprint.

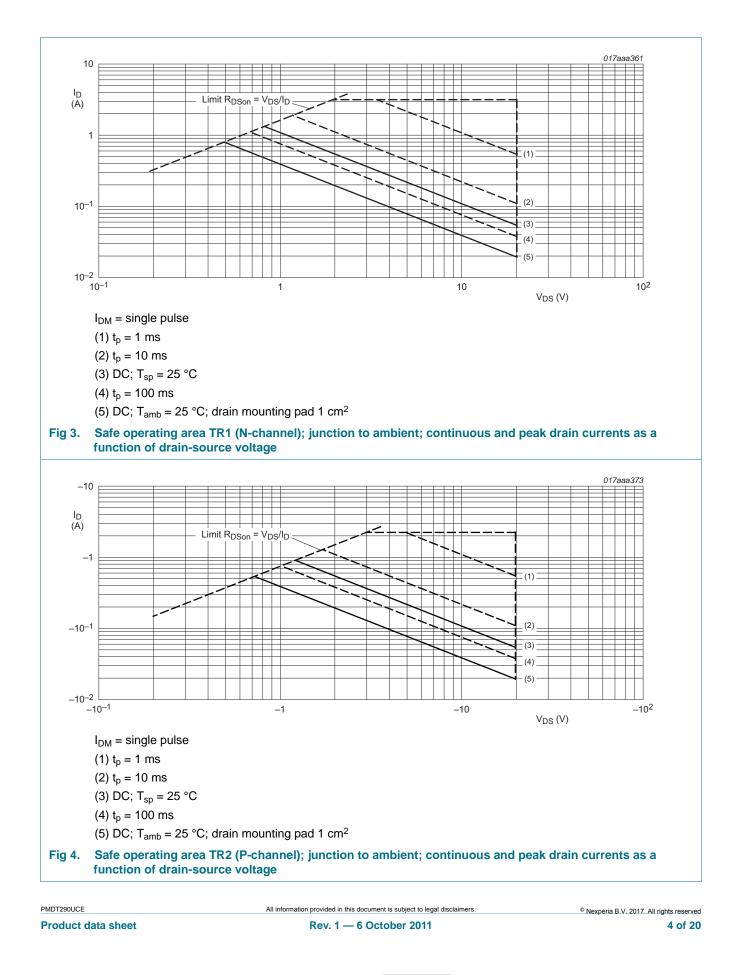
[3] Measured between all pins.



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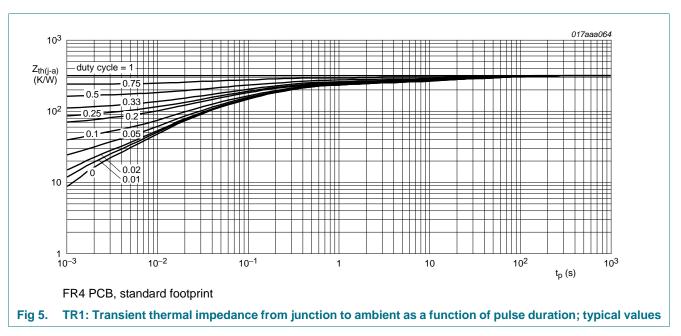
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6. Thermal characteristics

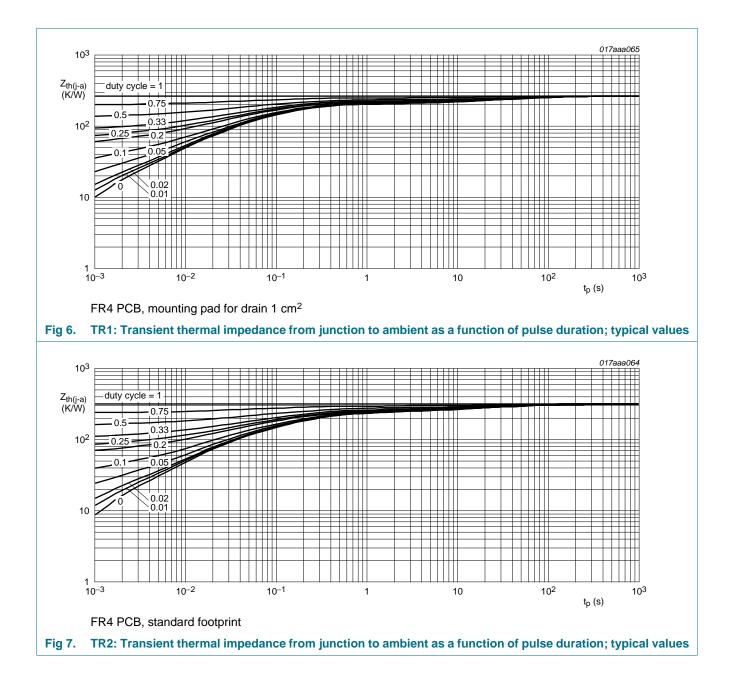
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
TR1 (N-cha	nnel)						
R _{th(j-a)}	thermal resistance	in free air	<u>[1]</u>	-	330	380	K/W
	from junction to ambient		[2]	-	280	320	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	-	115	K/W
TR2 (P-cha	nnel)						
R _{th(j-a)}	thermal resistance	in free air	[1]	-	330	380	K/W
	from junction to ambient		[2]	-	280	320	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	-	115	K/W
Per device							
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]	-	-	250	K/W

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper; tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm².

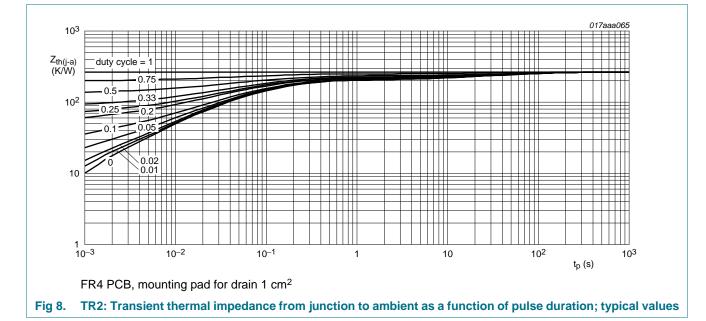


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20 / 20 V, 800 / 550 mA N/P-channel Trench MOSFET



7. Characteristics

Table 7.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1 (N-cl	nannel), Static characteristic	s				
V _{(BR)DSS}	drain-source breakdown voltage	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^{\circ}C$	20	-	-	V
V _{GSth}	gate-source threshold voltage	$I_D = 250 \ \mu A; \ V_{DS} = V_{GS}; \ T_j = 25 \ ^{\circ}C$	0.5	0.75	0.95	V
I _{DSS}	drain leakage current	$V_{DS} = 20 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	1	μA
		$V_{DS} = 20 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 150 \text{ °C}$	-	-	10	μA
I _{GSS}	gate leakage current	$V_{GS} = 8 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	2	μA
		V_{GS} = -8 V; V_{DS} = 0 V; T_j = 25 °C	-	-	2	μA
		V_{GS} = 4.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-	500	nA
		V_{GS} = -4.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-	500	nA
R_{DSon}	drain-source on-state	V_{GS} = 4.5 V; I_D = 500 mA; T_j = 25 °C	-	290	380	mΩ
	resistance	V_{GS} = 4.5 V; I_D = 500 mA; T_j = 150 °C	-	460	610	mΩ
		V_{GS} = 2.5 V; I _D = 200 mA; T _j = 25 °C	-	420	620	mΩ
		V_{GS} = 1.8 V; I _D = 10 mA; T _j = 25 °C	-	0.6	1.1	Ω
9 _{fs}	transfer conductance	V_{DS} = 10 V; I _D = 200 mA; T _j = 25 °C	-	1.6	-	S
TR1 (N-cl	nannel), Dynamic characteri	stics				
Q _{G(tot)}	total gate charge	V_{DS} = 10 V; I _D = 500 mA; V _{GS} = 4.5 V;	-	0.45	0.68	nC
Q _{GS}	gate-source charge	T _j = 25 °C	-	0.15	-	nC
Q _{GD}	gate-drain charge		-	0.15	-	nC

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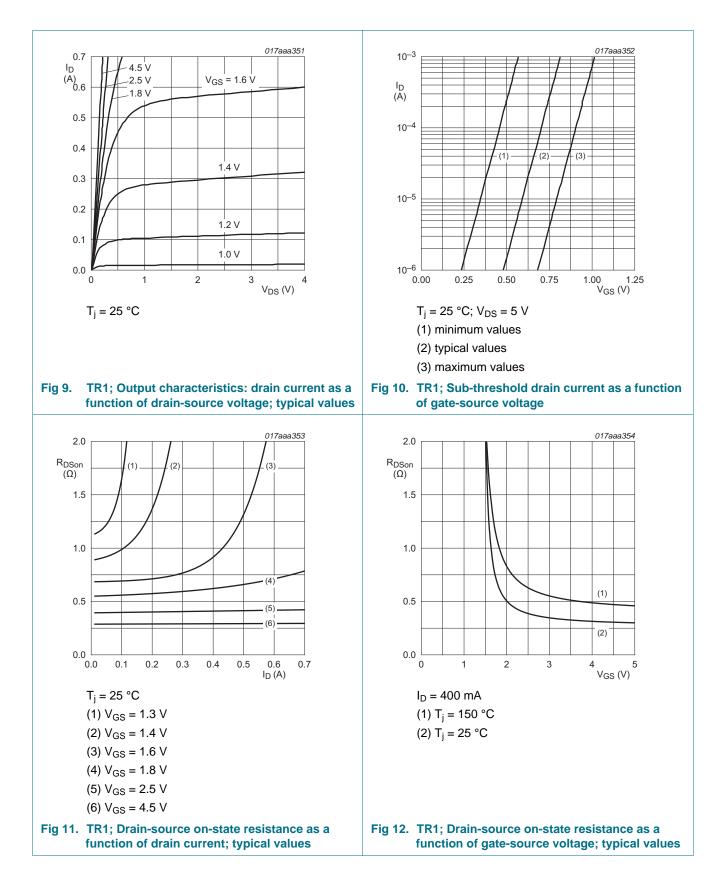
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Table 7. C	Characteristics continued					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C _{iss}	input capacitance	$V_{DS} = 10 \text{ V}; \text{ f} = 1 \text{ MHz}; \text{ V}_{GS} = 0 \text{ V};$	-	55	83	pF
C _{oss}	output capacitance	T _j = 25 °C	-	15	-	pF
C _{rss}	reverse transfer capacitance		-	7	-	pF
t _{d(on)}	turn-on delay time			6	12	ns
t _r	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 °C$	-	4	-	ns
t _{d(off)}	turn-off delay time		-	86	172	ns
t _f	fall time		-	31	-	ns
TR1 (N-chai	nnel), Source-drain diode	characteristics				
V _{SD} TR2 (P-char	source-drain voltage	I _S = 300 mA; V _{GS} = 0 V; T _j = 25 °C s	0.48	0.77	1.2	V
V _{(BR)DSS}	drain-source breakdown voltage	I_D = -250 $\mu\text{A};V_{GS}$ = 0 V; T_j = 25 °C	-20	-	-	V
V _{GSth}	gate-source threshold voltage	$I_D = -250 \ \mu\text{A}; \ V_{DS} = V_{GS}; \ T_j = 25 \ ^\circ\text{C}$	-0.5	-0.8	-1.3	V
I _{DSS}	drain leakage current	V_{DS} = -20 V; V_{GS} = 0 V; T_j = 25 °C	-	-	-1	μA
		V_{DS} = -20 V; V_{GS} = 0 V; T_j = 150 °C	-	-	-10	μΑ
I _{GSS}	s gate leakage current	$V_{GS} = 8 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	-2	μA
		V_{GS} = -8 V; V_{DS} = 0 V; T_j = 25 °C	-	-	-2	μA
		V_{GS} = 4.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-	-0.5	μA
		V_{GS} = -4.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-	-0.5	μA
R _{DSon}	drain-source on-state	V_{GS} = -4.5 V; I _D = -400 mA; T _j = 25 °C	-	0.67	0.85	Ω
	resistance	V_{GS} = -4.5 V; I _D = -400 mA; T _j = 150 °C	-	1.1	1.4	Ω
		V_{GS} = -2.5 V; I _D = -200 mA; T _j = 25 °C	-	1.2	1.5	Ω
		V_{GS} = -1.8 V; I _D = -10 mA; T _j = 25 °C	-	1.8	2.8	Ω
9fs	transfer conductance	V_{DS} = -10 V; I _D = -200 mA; T _j = 25 °C	-	610	-	mS
TR2 (P-char	nnel), Dynamic characteris	stics				
Q _{G(tot)}	total gate charge	V_{DS} = -10 V; I _D = -400 mA;	-	0.76	1.14	nC
Q _{GS}	gate-source charge	V _{GS} = -4.5 V; T _j = 25 °C	-	0.28	-	nC
Q _{GD}	gate-drain charge		-	0.18	-	nC
C _{iss}	input capacitance	V_{DS} = -10 V; f = 1 MHz; V_{GS} = 0 V;	-	58	87	pF
C _{oss}	output capacitance	$T_j = 25 \ ^{\circ}C$	-	21	-	pF
C _{rss}	reverse transfer capacitance		-	12	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = -10 V; R_{L} = 250 Ω; V_{GS} = -4.5 V;	-	18	36	ns
t _r	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 \ ^{\circ}C$	-	30	-	ns
t _{d(off)}	turn-off delay time		-	80	160	ns
t _f	fall time		-	72	-	ns
	nnel), Source-drain diode	characteristics				
V _{SD}	source-drain voltage	I _S = -300 mA; V _{GS} = 0 V; T _i = 25 °C	-0.48	-0.84	-1.2	V

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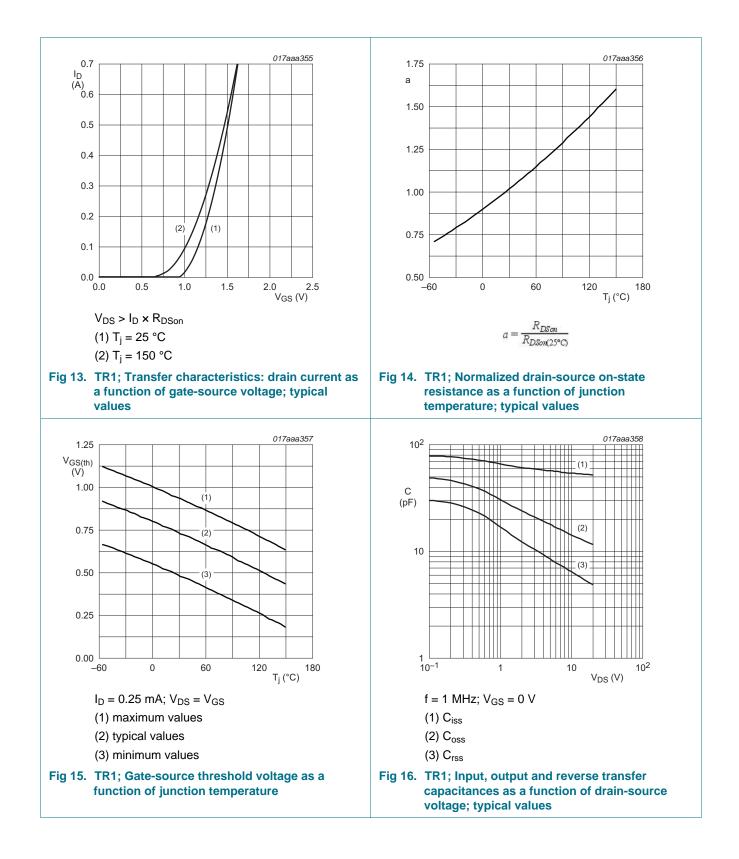


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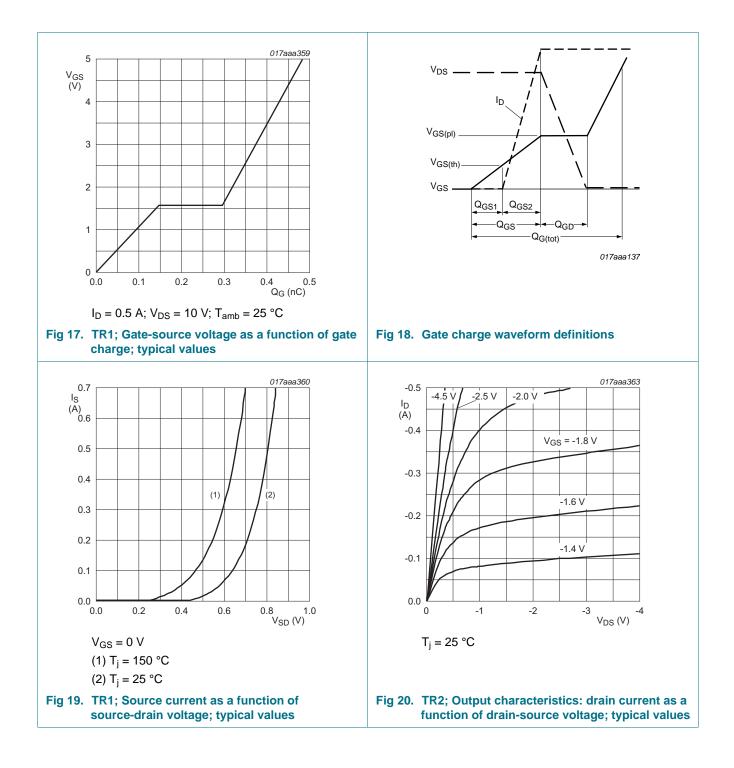
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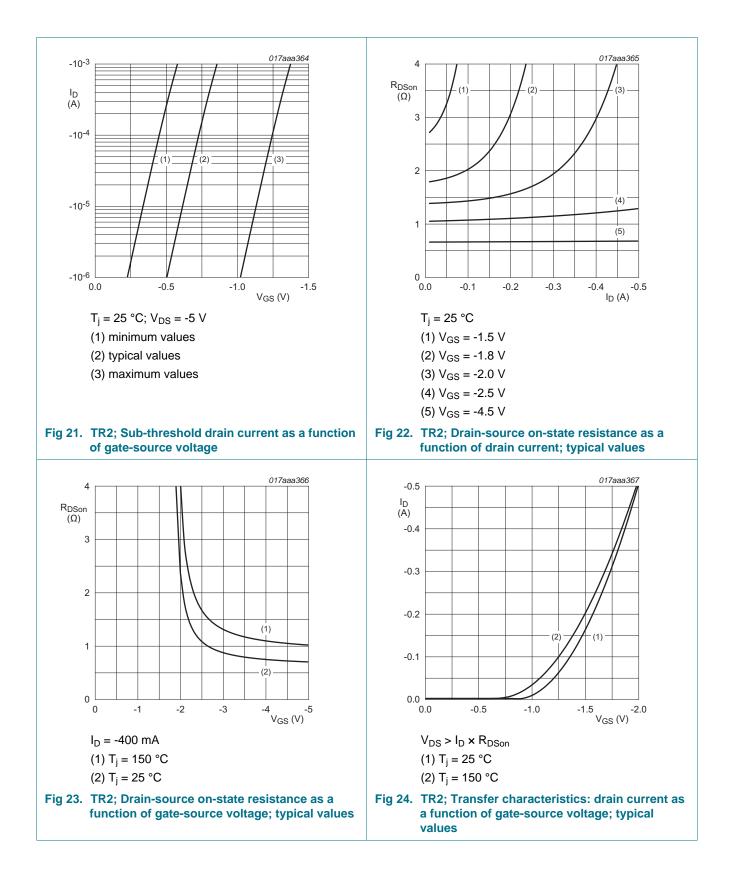


Rev. 1 — 6 October 2011

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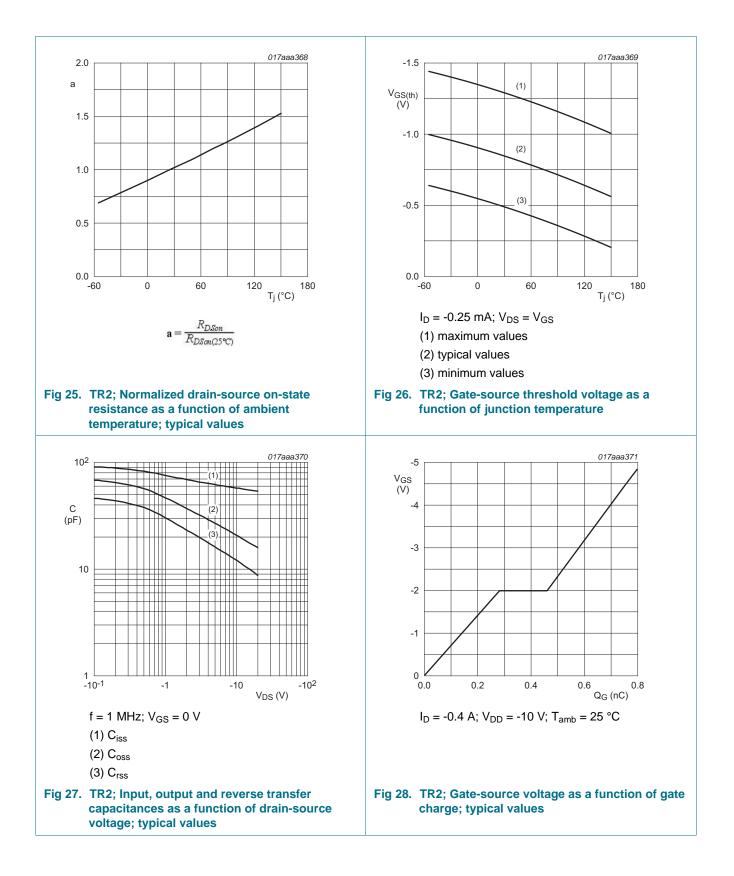


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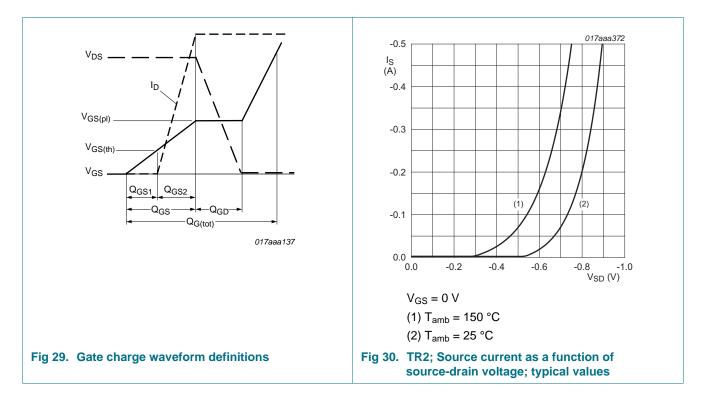
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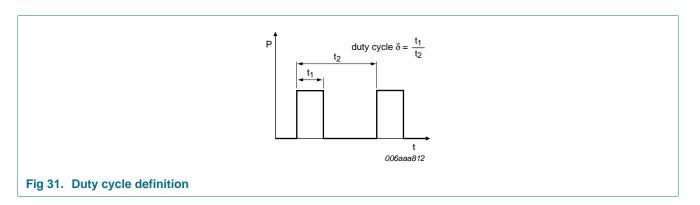


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8. Test information



8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

Rev. 1 — 6 October 2011

20 / 20 V, 800 / 550 mA N/P-channel Trench MOSFET

9. Package outline

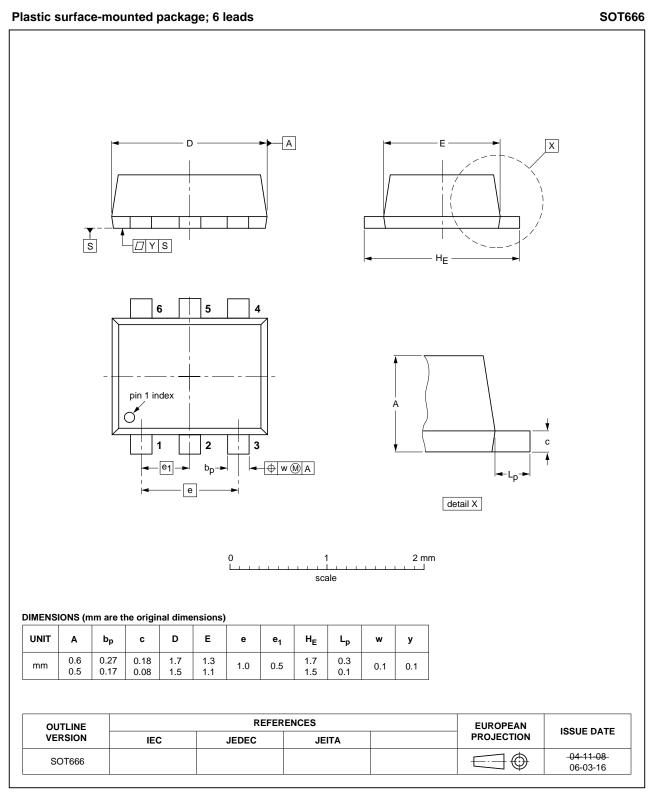
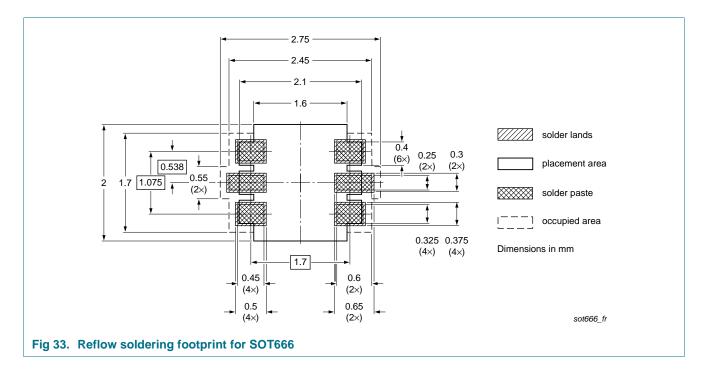


Fig 32. Package outline SOT666

PMDT290UCE Product data sheet

20 / 20 V, 800 / 550 mA N/P-channel Trench MOSFET

10. Soldering



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11. Revision history

Table 8. R	Revision history					
Document I	כ	Release date	Data sheet status	Change notice	Supersedes	
PMDT290UC	E v.1	20111006	Product data sheet	-	-	

12. Legal information

12.1 Data sheet status

Document status [1] [2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Product data sheet

Rev. 1 — 6 October 2011

20 / 20 V, 800 / 550 mA N/P-channel Trench MOSFET

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PMDT290UCE Product data sheet

20 / 20 V, 800 / 550 mA N/P-channel Trench MOSFET

14. Contents

1	Product profile1
1.1	General description1
1.2	Features and benefits
1.3	Applications1
1.4	Quick reference data1
2	Pinning information2
3	Ordering information2
4	Marking2
5	Limiting values2
6	Thermal characteristics5
7	Characteristics7
8	Test information14
8.1	Quality information14
9	Package outline15
10	Soldering16
11	Revision history17
12	Legal information18
12.1	Data sheet status
12.2	Definitions
12.3	Disclaimers
12.4	Trademarks
13	Contact information19

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